

IFX20001

Low Dropout Voltage Regulator

IFX20001MBV33
IFX20001MBV50

Data Sheet

Rev. 1.02, 2010-05-20

Standard Power



1 Overview

Features

- Two output voltage versions: 3.3 V, 5.0 V
- Very low drop voltage 300mV
- Output current: 30 mA
- Inhibit function
- Low quiescent current consumption
- Input voltage up to 45 V
- Wide temperature range: $-40\text{ °C} \leq T_j \leq 125\text{ °C}$
- Output protected against short circuit
- Overtemperature protection
- Reverse polarity protection
- Very small and thermally enhanced package
- Green Product (RoHS compliant)

Applications

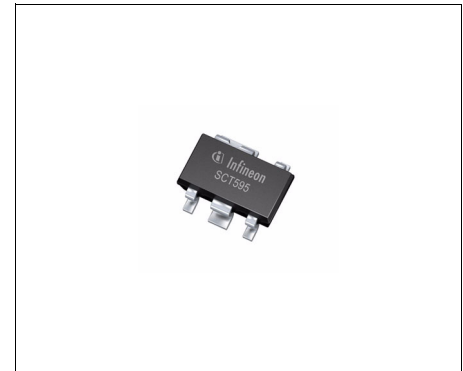
- Manufacturing Automation
- Appliances
- HDTV Televisions
- Game Consoles
- Network Routers

For automotive and transportation applications, please refer to the Infineon TLE and TLF voltage regulator series.

Description

The **IFX20001** is a monolithic integrated low-drop voltage regulator in the very small SMD package PG-SCT595-5. It is designed to supply various loads (e.g. microprocessor) under over severe conditions. Therefore the device is equipped with additional protection functions against overload, short circuit and reverse polarity. In case of an overtemperature condition the regulator is automatically turned off by the integrated thermal protection circuit.

Input voltages up to 45 V are regulated to $V_{Q,nom} = 3.3\text{ V}$ (V33 version) or 5.0 V (V50 version). The output is able to drive a load of 30 mA while it regulates the output voltage within a 4% accuracy. To save energy the device can be switched in stand-by mode via an inhibit input which causes the current consumption to drop below 5 μA .



PG-SCT595-5

Type	Package	Marking
IFX20001MBV33	PG-SCT595-5	V3
IFX20001MBV50	PG-SCT595-5	V5

2 Block Diagram

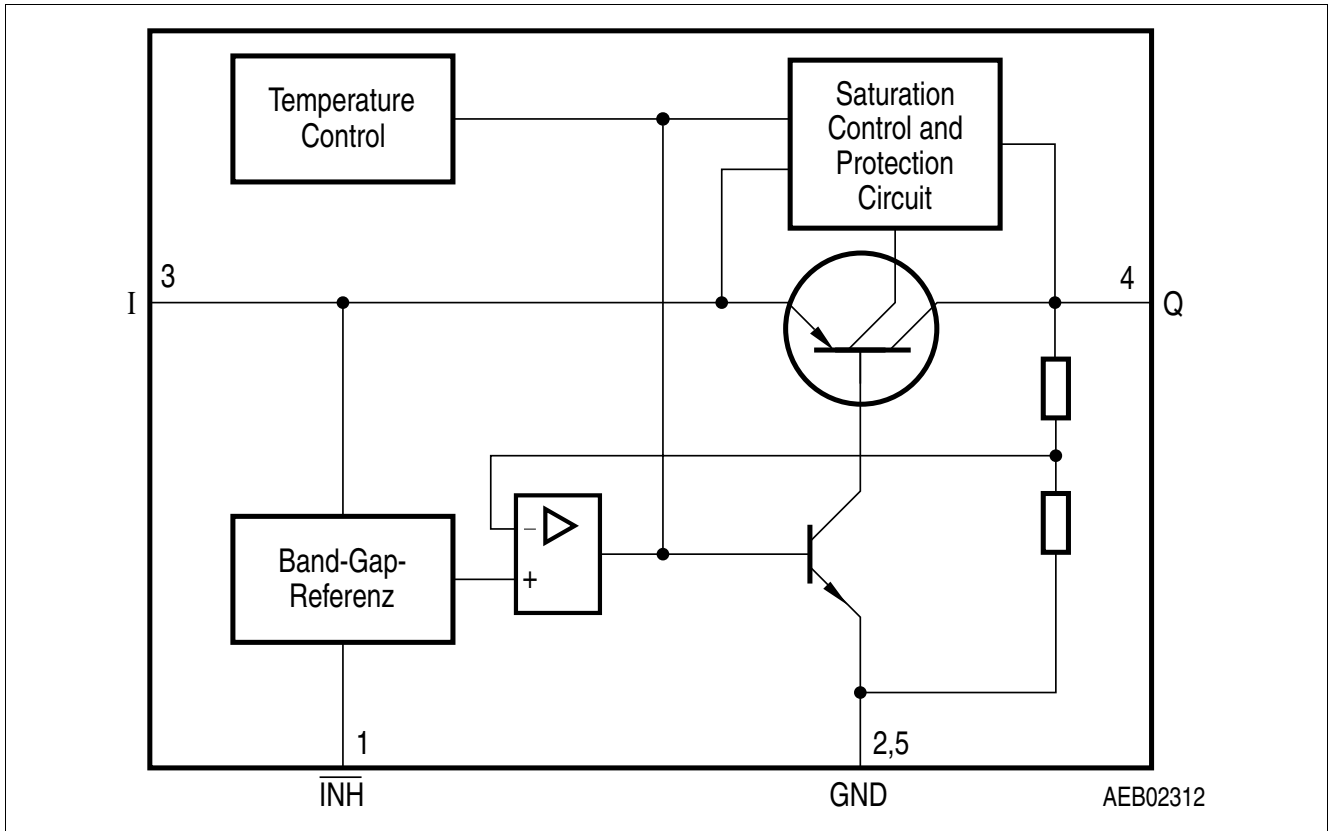


Figure 1 Block Diagram

3 Pin Configuration

3.1 Pin Assignment

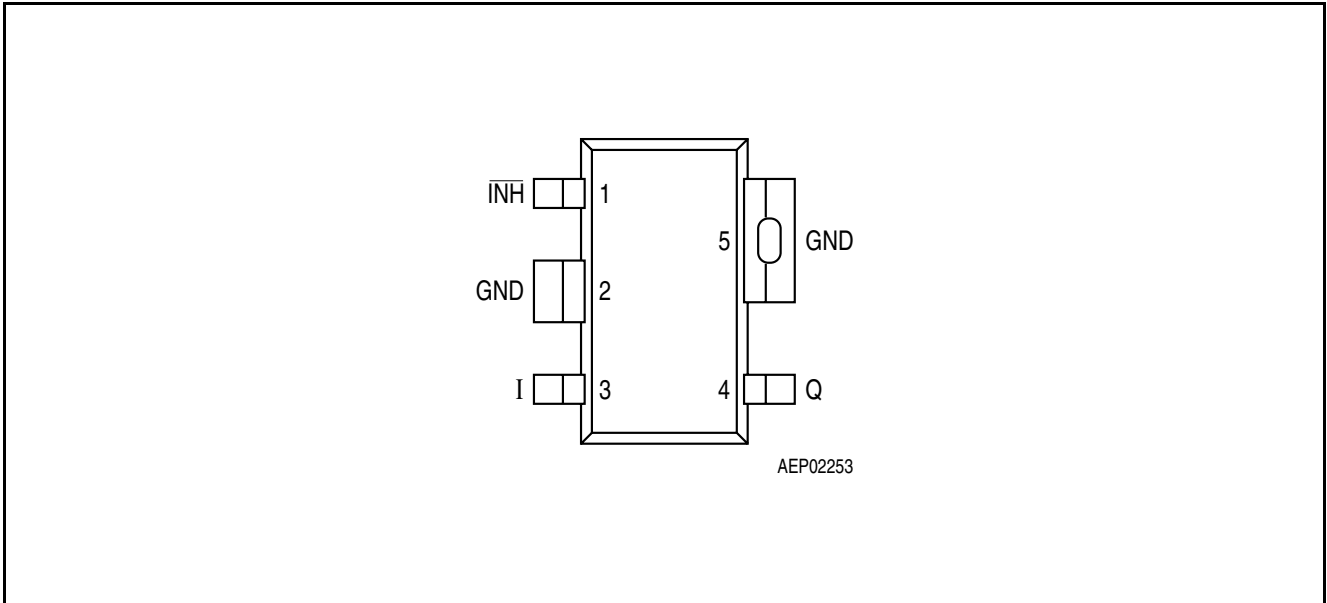


Figure 2 Pin Configuration (top view)

3.2 Pin Definitions and Functions

Table 1 Pin Definitions and Functions Fixed Output Voltage Versions

Pin No.	Symbol	Function
1	INH	Inhibit input ; high level to turn on the IC
2	GND	Ground ; connected to pin 5
3	I	Input voltage
4	Q	Output voltage ; must be blocked with a ceramic capacitor $C_Q \geq 3.3 \mu\text{F}$, $\text{ESR} \leq 2 \Omega$
5	GND	Ground ; connected to pin 2

4 General Product Characteristics

4.1 Absolute Maximum Ratings

Absolute Maximum Ratings¹⁾

$T_j = -40\text{ °C}$ to 150 °C ; all voltages with respect to ground, (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values		Unit	Test Condition
			Min.	Max.		
Input I						
4.1.1	Voltage	V_I	-42	45	V	–
Output Q						
4.1.2	Voltage	V_Q	-0.3	30	V	–
Inhibit						
4.1.3	Voltage	V_{INH}	-42	45	V	
4.1.4	Current	I_{INH}	-500	*	μA	* internally limited
4.1.5	Current	I_{INH}	-5	5	mA	$-0.3\text{ V} < V_I < 45\text{ V}$; $t_p < 1\text{ ms}$
Temperature						
4.1.6	Junction temperature	T_j	-40	150	$^{\circ}\text{C}$	–
4.1.7	Storage temperature	T_{stg}	-50	150	$^{\circ}\text{C}$	–

1) not subject to production test, specified by design

Note: Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as “outside” normal operating range. Protection functions are not designed for continuous repetitive operation.

4.2 Functional Range

Pos.	Parameter	Symbol	Limit Values		Unit	Remarks
			Min.	Max.		
4.2.1	Input voltage	V_I	4.0	45	V	IFX20001MBV33
4.2.2	Input Voltage	V_I	5.5	45	V	IFX20001MBV50
4.2.3	Inhibit Voltage	V_{INH}	-0.3	40	V	
4.2.4	Junction temperature	T_j	-40	125	°C	–

Note: Within the functional or operating range, the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the Electrical Characteristics table.

4.3 Thermal Resistance

Note: This thermal data was generated in accordance with JEDEC JESD51 standards. For more information, go to www.jedec.org.

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Typ.	Max.		
4.3.5	Junction to Ambient	R_{thJA}	–	81	–	K/W	2s2p board ¹⁾
4.3.1			–	217	–	K/W	Footprint only ²⁾
4.3.2			–	117	–	K/W	300 mm ² PCB heatsink area ²⁾
4.3.3			–	103	–	K/W	600 mm ² PCB heatsink area ²⁾
4.3.4	Junction to Soldering Point	R_{thJSP}	–	30	–	K/W	Pins 2, 5 fixed to T_A

- 1) Specified R_{thJA} value is according to JESD51-2,-5,-7 at natural convection on FR4 2s2p board; The product (chip+package) was simulated on a 76.2 x 114.3 x 1.5 mm board with 2 inner copper layers (2 x 70µm Cu, 2 x 35µm Cu). Where applicable a thermal via array under the package contacted the first inner copper layer.
- 2) Package mounted on PCB FR4; 80 x 80 x 1.5 mm; 35 µm Cu, 5 µm Sn; horizontal position; zero airflow. Not subject to production test; specified by design.

5 Electrical Characteristics

5.1 Electrical Characteristics Voltage Regulator

Table 2 Electrical Characteristics
 $V_I = 13.5\text{ V}$; $V_{INH} > +2.5\text{ V}$; $-40\text{ °C} < T_j < 125\text{ °C}$; unless otherwise specified

Parameter	Symbol	Limit Values			Unit	Test Condition
		Min.	Typ.	Max.		
Output voltage V33 version	V_Q	3.17	3.30	3.43	V	$1\text{ mA} < I_Q < 30\text{ mA}$ $V_I = 13.5\text{ V}$
		3.17	3.30	3.43	V	$I_Q = 10\text{ mA}$ $4.3\text{ V} < V_I < 40\text{ V}$
Output voltage V50 version	V_Q	4.80	5.00	5.20	V	$1\text{ mA} < I_Q < 30\text{ mA}$ $V_I = 13.5\text{ V}$
		4.80	5.00	5.20	V	$I_Q = 10\text{ mA}$ $6\text{ V} < V_I < 40\text{ V}$
Output current limitation	I_Q	30	–	–	mA	¹⁾
Drop voltage	V_{dr}	–	0.25	0.30	V	$I_Q = 20\text{ mA}$ ¹⁾
Output capacitor	C_Q	3.3	–	–	μF	$\text{ESR} \leq 2\ \Omega$ at 10 kHz
Current consumption $I_q = I_I - I_Q$	I_q	–	2	5.2	mA	$I_Q < 30\text{ mA}$
Current consumption $I_q = I_I - I_Q$	I_q	–	130	170	μA	$I_Q < 0.1\text{ mA}$; $T_j < 85\text{ °C}$
Quiescent current (stand-by) $I_q = I_I - I_Q$	I_q	–	0	1	μA	$V_{INH} = 0.4\text{ V}$; $T_j < 85\text{ °C}$
Quiescent current (stand-by) $I_q = I_I - I_Q$	I_q	–	0	5	μA	$V_{INH} = 0.4\text{ V}$
Load regulation	ΔV_Q	–	17	50	mV	$1\text{ mA} < I_Q < 25\text{ mA}$; $T_j = 25\text{ °C}$ IFX20001MBV50
		–	14	40	mV	$1\text{ mA} < I_Q < 25\text{ mA}$; $T_j = 25\text{ °C}$ IFX20001MBV33
Line regulation	ΔV_Q	–	10	25	mV	$V_I = (V_{Q,nom} + 0.5\text{ V})$ to 36 V $I_Q = 5\text{ mA}$; $T_j = 25\text{ °C}$
Power Supply Ripple Rejection	$PSRR$	–	60	–	dB	$f_r = 100\text{ Hz}$; $V_r = 0.5\text{ Vpp}$

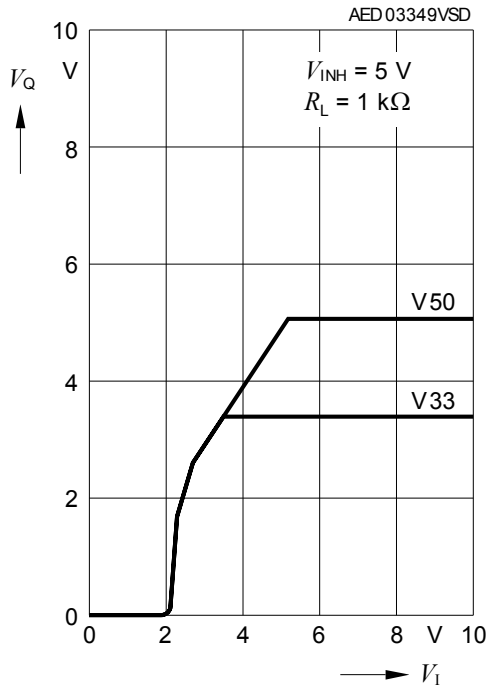
Inhibit Input

Inhibit, Turn-on voltage	$V_{INH, high}$	–	–	2.2	V	$V_Q > 0.95 V_{Q,nom}$
Inhibit, Turn-off voltage	$V_{INH, low}$	0.4	–	–	V	$V_Q > 0.1\text{ V}$
H-input current	$I_{INH, high}$	–	8	12	μA	$V_{INH} = 5\text{ V}$
L-input current	$I_{INH, low}$	-2	–	2	μA	$V_{INH} = 0\text{ V}$

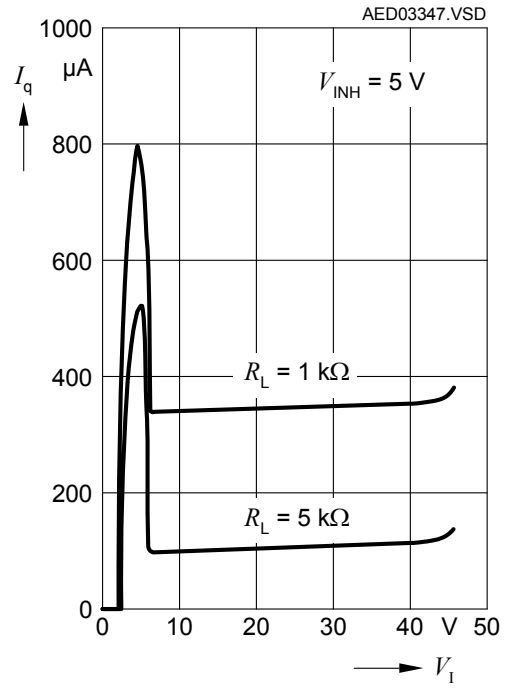
¹⁾ Measured when the output voltage v_Q has dropped 100 mV from the nominal value.

5.2 Typical Performance Characteristics Voltage Regulator

Output Voltage V_Q versus Input Voltage V_I



Current Consumption I_q versus Input Voltage V_I



6 Application Information

Note: The following information is given as a hint for the implementation of the device only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.

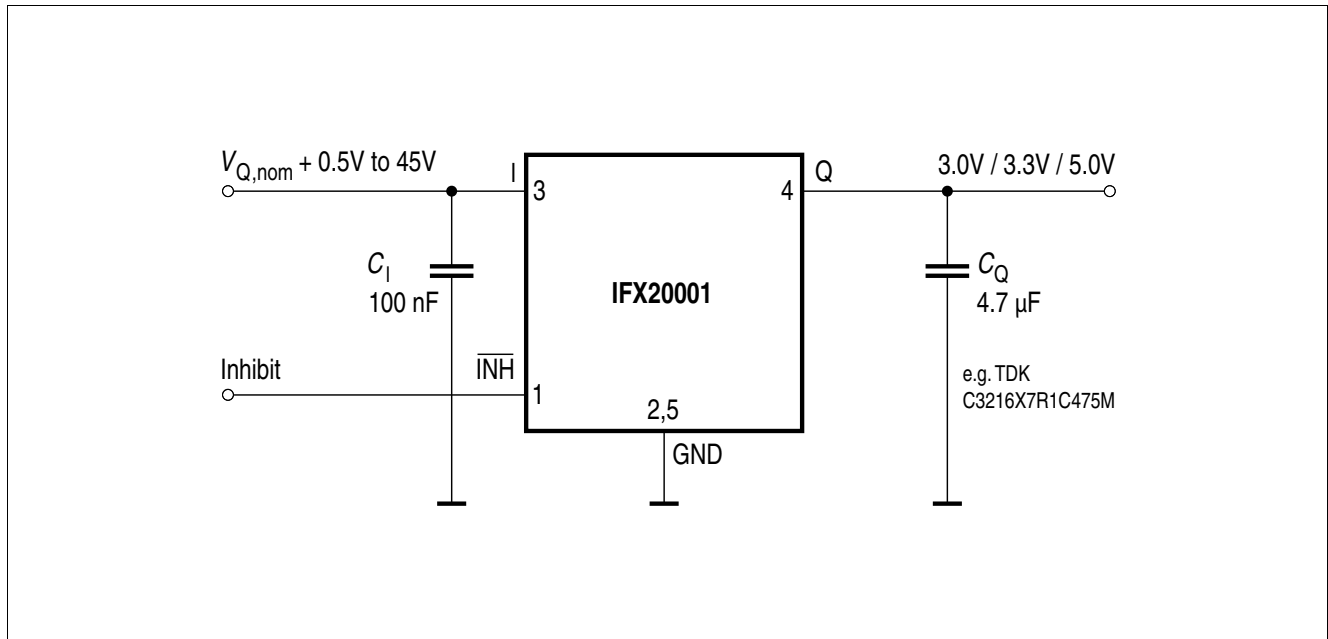


Figure 3 Application Diagram

Application Hints

In the IFX20001 the output voltage is divided and compared to an internal reference of 2.5 V typical. The regulation loop controls the output to achieve a stabilized output voltage.

Figure 3 shows a typical application circuit. In order to maintain the stability of the control loop the IFX20001 output requires an output capacitor C_Q of at least 3.3 μF with a maximum permissible ESR of 2 Ω . It is recommended to use a multi layer ceramic capacitor for C_Q . If aluminum electrolytic and tantalum capacitors are selected as output capacitors they must be carefully chosen to cover the required ESR range over the full operating temperature range of -40 $^{\circ}\text{C}$ to 125 $^{\circ}\text{C}$.

At the input of the regulator a capacitor is required for compensating line influences. A resistor of approximately 1 Ω in series with the input capacitor (C_1) can dampen oscillations that could occur due to the input line inductance and the input capacitor. If the regulator is sourced via long input lines of several meters it is recommended to place an additional capacitor $\geq 47 \mu\text{F}$ at the input.

7 Package Outlines

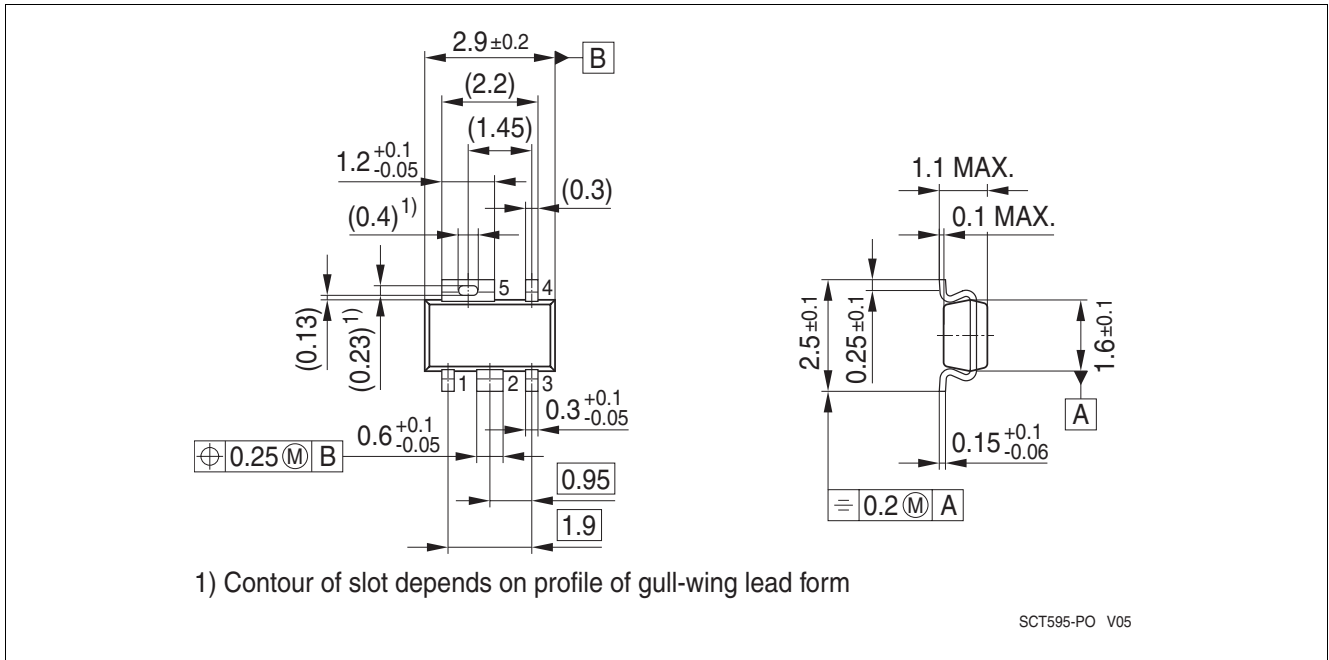


Figure 4 PG-SCT595-5

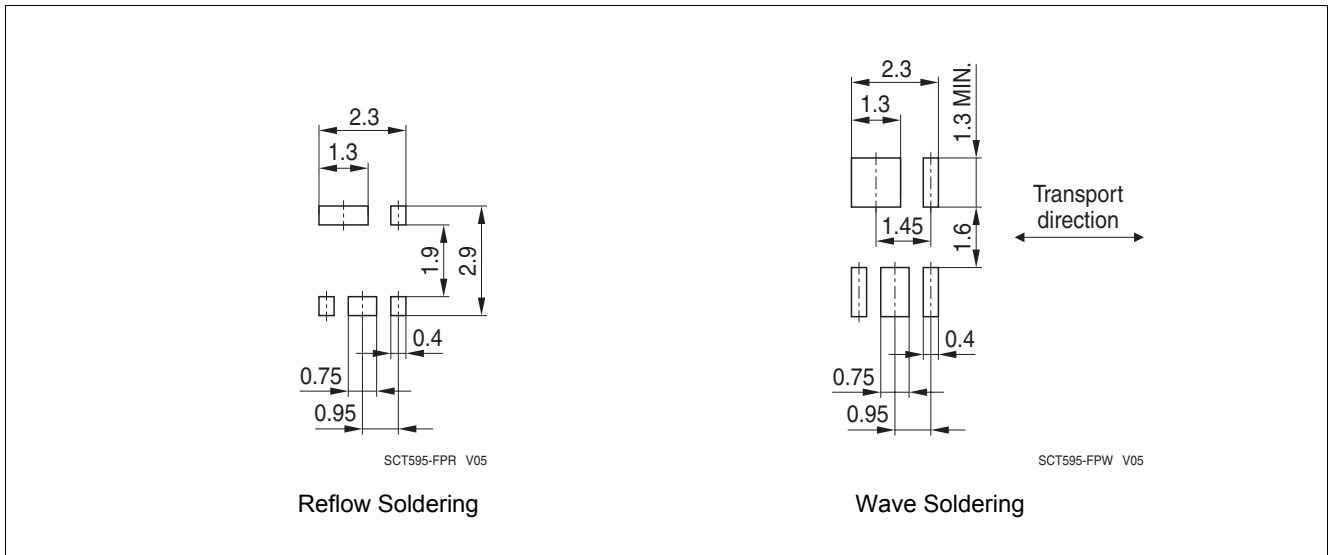


Figure 5 Footprint PG-SCT595-5

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

For further information on packages, please visit our website:
<http://www.infineon.com/packages>.

Dimensions in mm

8 Revision History

Revision	Date	Changes
1.02	2010-05-20	Editorial change (fig. 3)
1.01	2009-09-10	Coverpage changed Overview page: Inserted reference statement to TLE/TLF series.
1.0	2009-04-28	Initial Release

Edition 2010-05-20

**Published by
Infineon Technologies AG
81726 Munich, Germany**

**© 2010 Infineon Technologies AG
All Rights Reserved.**

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.